



**Certificate Concerning Xilinx Standard Programmable Logic Devices
and RoHS Compliance
(‘5 of 6’ Disclosure)**

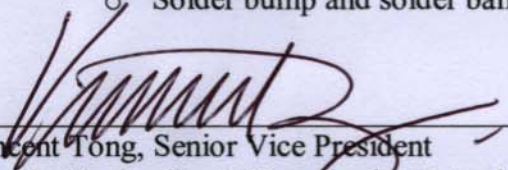
Xilinx, Inc. certifies that to the best of its knowledge, the Xilinx standard programmable logic devices conform to the requirements of 2002/95/EC, the European Union Restriction on the Use of Hazardous Substances (RoHS) Directive, for five (5) of the six (6) identified substances within the Directive – specifically cadmium, mercury, hexavalent chromium, polybrominated biphenyl and polybrominated diphenyl ether (which includes decabromodiphenyl ethers). These five (5) identified substances are not contained in Xilinx’ standard programmable logic devices and comply with the limits in the following table:

Banned Substance	Maximum Concentration Values (ppm)
Cadmium	100
Mercury	1000
Hexavalent Chromium	1000
Polybrominated Biphenyl (PBB)	1000
Polybrominated Diphenyl Ether (PBDE)	1000

Xilinx’ standard programmable logic devices do contain lead above the maximum permitted concentration value of 1000 ppm established in the EU RoHS directive.

Lead is found only in the following areas of the Xilinx standard package:

- Leaded frame packages
 - External lead plating composition
- Ball Grid Array (BGA) packages
 - Solder ball composition
- Flip Chip BGA packages
 - Solder bump and solder ball composition



Vincent Tong, Senior Vice President
Worldwide Quality & New Product Introductions

5/28/2008
Date

Important Information and Disclaimer: The statements made herein are based on understanding by Xilinx of the RoHS Directive and its knowledge of the materials used in the manufacture of its products as of the date of such statements. Information provided by Xilinx on its website or in other company communications concerning the content of its products represents the knowledge and belief of Xilinx as of the date that it is provided. All statements are contingent upon the accuracy of such information. Xilinx continues to take steps to provide accurate information but, in some cases, may not conduct destructive testing or chemical analysis on incoming materials and chemicals.